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PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Serial No.: 10/519,932

Confirmation No.: 5027

In re Application of:

Kazuaki ABE et al.

Group Art Unit: 1774

Filed: December 29, 2004

For: HEAT-ACCUMULATIVE MATERIAL, COMPOSITION THEREOF,
AND USE OF THE MATERIAL AND COMPOSITION

INFORMATION DISCLOSURE STATEMENT
PURSUANT TO 37 CFR 1.97(c)(1)

Customer Window
U.S. PATENT AND TRADEMARK OFFICE
Randolph Building
401 Dulany Street
Alexandria, VA 22314

Sir:

Pursuant to 37 CFR 1.56, the attention of the Patent and Trademark Office is hereby directed to the reference listed on the attached Form PTO-1449, which includes the reference cited in an Office Action mailed March 16, 2007 in corresponding Chinese Application No. 03805772.7. A copy of the Office Action, its English translation and cited reference is enclosed.

Inasmuch as each item of information contained herein was first cited in a communication from a foreign patent office in a counterpart foreign application not more than three months prior to this filing, no fee is due.

It is respectfully requested that this information be expressly considered during the prosecution of this application, and that this reference be made of record therein and appear among the "References Cited" on any patent to issue therefrom.

Respectfully Submitted,

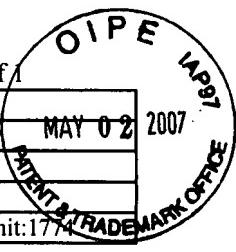
STEPTOE & JOHNSON LLP



Roger W. Parkhurst
Registration No. 25,177

Atty. Dkt: 28955.1043

STEPTOE & JOHNSON LLP
1330 Connecticut Ave., N.W.
Washington, D.C. 20036
(202) 429-6420



Sheet 1 of 1

FORM 1449 (S&J Version)	Docket No.: 28955.1043
INFORMATION DISCLOSURE STATEMENT BY APPLICANT	Applicant: K. ABE et al.
	Application No.: 10/519,932
	Filing Date: 12/29/2004
	Examiner:
	Group Art Unit: 1774 TRADE

U.S. PATENT DOCUMENTS

FOREIGN PATENT DOCUMENTS

OTHER DOCUMENTS

Examiner's Signature		Date Considered	
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*EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609. Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.